

# Comparison of Sintering Aids for Low Temperature Sintering of Hard PZT

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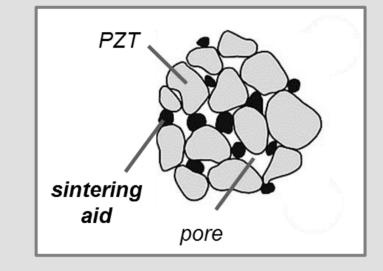
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## Introduction

PZT (PbZr<sub>x</sub>Ti<sub>1-x</sub>O<sub>3</sub>) is the most commonly used piezo ceramic

**IMTEK** 

- 100 µm thick PZT-films were fabricated by tape casting methode and sintered in air for 3h @ 900 °C instead of normally needed 1200 °C
- Used Technique:



## LIQUID-PHASE SINTERING

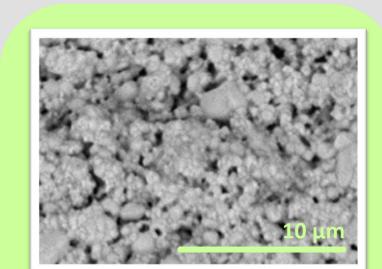
Acceleration of densification of the major phase particles (PZT) by adding of lower melting sintering aids which form a liquid phase and facilitate the rearrangement and grain growth of the

# **Advantages of LT-Sintering of PZT**

MATERIAL COMPATIBILITY	STABILIZATION OF ELECTROMECH. PROP.	REDUCTION OF PROCESS COSTS
Co-firing of	Evaporation of volatile PbO out of	Less cost-effective electrodes
multilayer stacks	PZT during the sintering process is	from Ag instead of Pt or Ag/Pd-alloys
made from PZT- and	suppressed, so that stoichiometric	Less environmental pollution
LTCC-layers or	composition of PZT is stabilized and	through evaporation of Pb-compounds
internal electrodes	subsequent piezoelectric	Less energy consumption
from pure Ag	components become more reliable	through lowered sintering temperatures

## **Results**

Sintering aid amount Contents of Li-compounds above 1 vol-% deteriorate the piezoelectr. prop. of PZT.



 $+ Bi_2O_3$ 

T<sub>m</sub> = 817 °C

Amount 2 vol-% 5 vol-%

ρ [%]

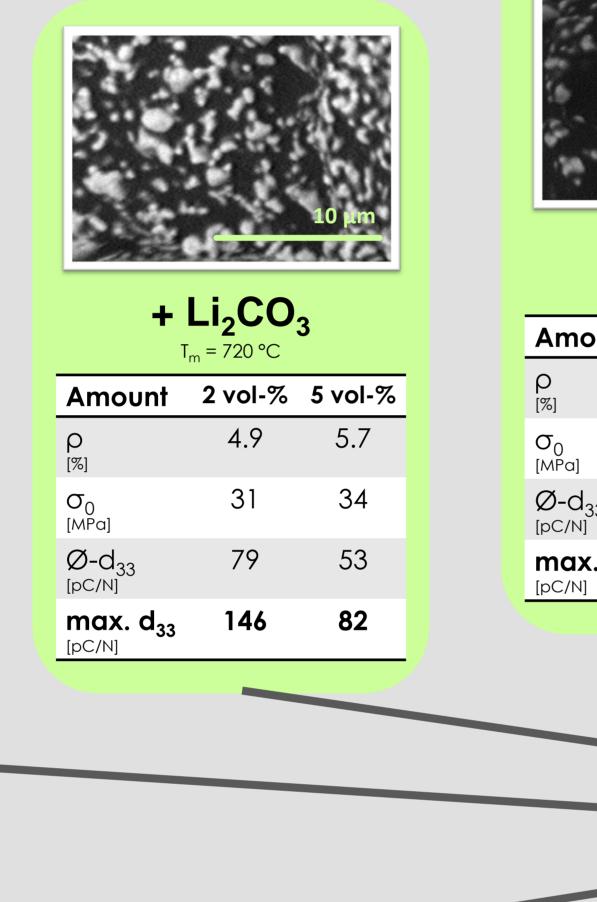
 $\sigma_0$ 

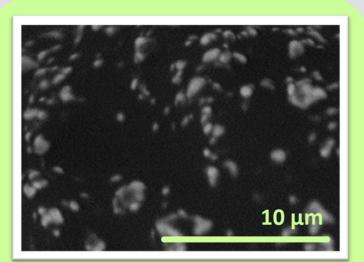
4.8

22

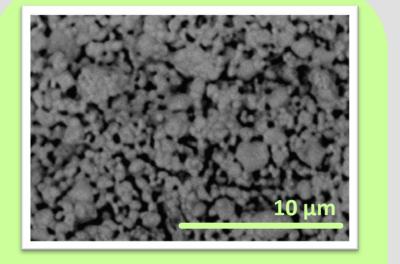
5.6

53





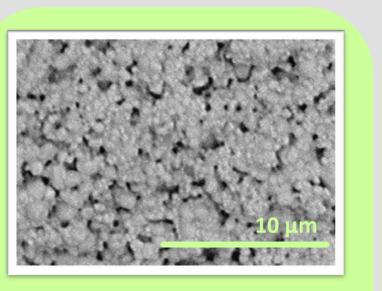
+ Li2O<br/> $T_m = 1427 \, {}^{\circ}C$ Amount2 vol-%5 vol-% $\rho$ <br/>[%]5.35.7 $\rho_{[\%]}$ 2924 $O_{0}_{[MPa]}$ 3417 $(D - d_{33}_{[PC/N]})$ 7437



+ MnO2<br/> $T_m = 535 \, {}^{\circ}C$ Amount2 vol-%5 vol-% $\rho$ <br/>[%]4.24.5 $\sigma_0$ <br/>[MPa]1210 $\emptyset$ -d33<br/>[pC/N]134max. d33145

[pC/N]

PZT



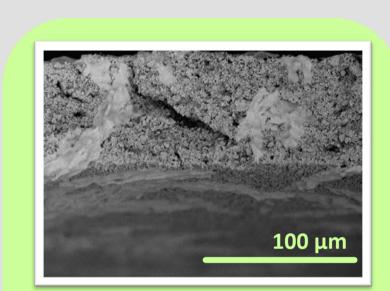
	<b>PbO</b> m = 888 °C	
Amount	2 vol-%	5 vol-9
р [%]	5.4	6.4
0 [МРа]	40	48
Ø-d <sub>33</sub> [pC/N]	30	34

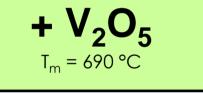
46

max. d<sub>33</sub>

#### Mechanical stability

High characteristic breaking strengths  $\sigma_0$  above 50 MPa were obtained for **addition of**  $V_2O_5$ , LBCu, CuO and higher amounts of PbO, Bi<sub>2</sub>O<sub>3</sub> or PbO·WO<sub>3</sub>

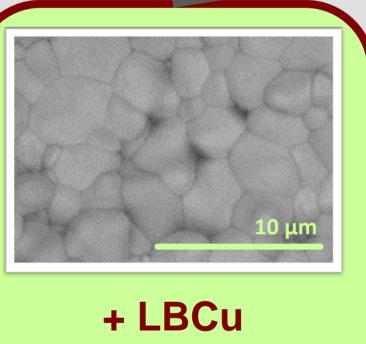




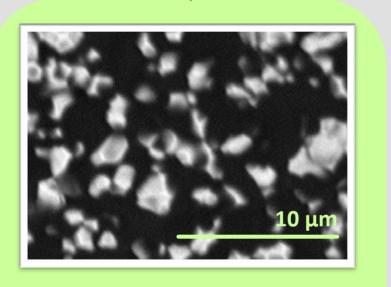
Amount	2 vol-%	5 vol-%
р [%]	5.7	5.8
$\sigma_0$	61	51

[pC/N]		
max. d <sub>33</sub>	42	71
Ø-d <sub>33</sub> [pC/N]	29	34
[MPa]		

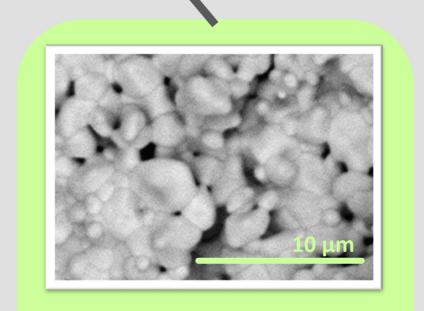
Piezoelectr. Properties
A sufficiently dense micro-
structure and the highest
piezoelectric charge constant
d <sub>33</sub> of 181 pC/N provide the
@ 900 °C for 3h sintered
PZT-films with sintering aid
<b>LBCu</b> (2 vol%).



	LDCU Bi <sub>2</sub> O <sub>3</sub> ·CuO (1	
Amount	2 vol-%	5 vol-%
ρ [%]	6.6	7.4
σ <sub>0</sub> [MPa]	49	77
Ø-d <sub>33</sub> [pC/N]	181	98
<b>max. d<sub>33</sub></b> [pC/N]	246	113



<b>- CuO</b> <sub>m</sub> = 1326 °C	
2 vol-%	5 vol-%
5.8	6.0
66	58
136	134
196	262
	m = 1326 °C <b>2 vol-%</b> 5.8 66 136



+ Cu <sub>2</sub> O·PbO eutectic mixture, T <sub>m</sub> = 680 °C					
Amount	2 vol-%	5 vol-%			
ρ [%]	5.7	5.6			
σ <sub>0</sub> [MPa]	45	36			
<b>Ø-d<sub>33</sub></b> [pC/N]	126	46			
<b>max. d<sub>33</sub></b> [pC/N]	151	52			

10 A	1.38	10.25
1	15	1
Ser.		1.0
231		10

## + PbO·WO<sub>3</sub> eutectic mixture, $T_m = 730$ °C Amount 2 vol-% 5 vol-%

<b>max. d<sub>33</sub></b> [pC/N]	67	185	
Ø-d <sub>33</sub> [pC/N]	59	143	
<b>Ο</b> <sub>0</sub> [MPa]	26	55	
р [%]	5.4	7.0	

max. d <sub>33</sub>	70	140
Ø-d <sub>33</sub> [pC/N]	51	67
[MPa]		

## <u>V<sub>2</sub>O<sub>5</sub> -Ligaments</u>

Addition of  $V_2O_5$  increases the mechanical stability by formation of  $V_2O_5$ -ligaments through the still porous PZTmatrix. Densification of the PZT particles remains low.

# Conclusion

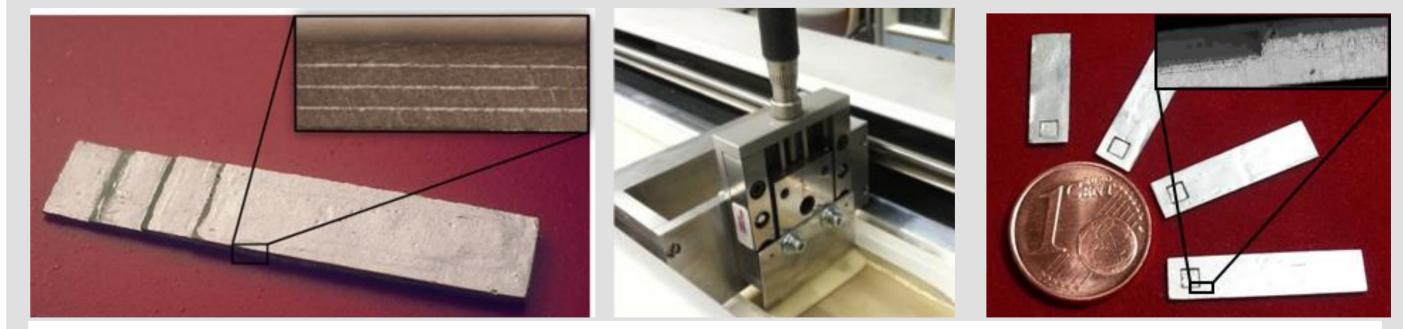
Most effective sintering aid for hard PZT is the ternary system LBCu (Li<sub>2</sub>CO<sub>3</sub>:Bi<sub>2</sub>O<sub>3</sub>:CuO, 1:1:4).

# Outlook

Development of a new fabrication method for piezoelectric bimorphs and multilayer by **Co-Casting** a whole stack of alternating sheets from PZT and Ag **instead of Tape Casting** of single PZT green tapes, which have to be

- Highest densification progress of PZT particles with a relative density of 97 ± 3 % and highest characteristic breaking strength of PZT-films sintered @ 900 °C was achieved with 5 vol-% LBCu as sintering aid.
- Highest piezoelectric charge constant in average (181 pC/N) was measured for PZT-films with 2 vol-% LBCu.
- The combination of hard PZT and CuO leads to increased piezoelectric properties, while contents of Li-compounds in the investigated volume range deteriorate the piezoelectric properties of PZT significantly.

### metallized individually, stacked properly and laminated without distortion.



Co-fired multilayer manufactured from Co-casting setup on First co-casted bimorphs metallized single green tapes. Access lab scale for multilayer tailored by punching out. to internal Ag-electrodes realized by stacks manufacturing Access to the internal Agstepped stacking with the problem that out of alternating cera- electrode was made by the undermost layer is not stable. mic and metal layers. laser treatment.



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